Not for New Designs

BYV26DGP, BYV26EGP



Superectifier[®]

DO-15 (DO-204AC)

1.0 A

800 V, 1000 V

30 A

75 ns

1.3 V

175 °C

DO-15 (DO-204AC)

Single

PRIMARY CHARACTERISTICS

I_{F(AV)}

V_{RRM}

I_{FSM} t_{rr}

 $V_{\rm F}$ at $I_{\rm F}$

T_J max.

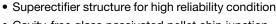
Package

Circuit configuration

Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier





- Cavity-free glass passivated pellet chip junction
- Ultrafast reverse recovery time
- Low forward voltage drop

FEATURES

- Low switching losses, high efficiency
- High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

MECHANICAL DATA

Case: DO-15 (DO-204AC), molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYV26DGP	BYV26EGP	UNIT		
Maximum repetitive peak reverse voltage	V _{RRM}	800	1000	V		
Maximum RMS voltage	V _{RMS}	560	700	V		
Maximum DC blocking voltage	V _{DC}	800	1000	V		
Maximum average forward rectified current 0.375" (9.5 mm) lead length (fig. 1)	I _{F(AV)}	1.0		А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А		
Non repetitive peak reverse energy	E _{RSM} ⁽¹⁾	10		mJ		
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175		°C		

Note

⁽¹⁾ Peak reverse energy measured at $I_R = 400$ mA, $T_J = T_J$ max. on inductive load, t = 20 µs



COMPLIANT



www.vishay.com

BYV26DGP, BYV26EGP

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYV26DGP	BYV26EGP	UNIT	
Minimum avalanche breakdown voltage	100 µA		V _{BR}	900	1100	V	
Maximum instantaneous forward voltage	104	T _J = 25 °C		2.5		V	
	1.0 A	T _J = 175 °C	V _F	1.3		v	
Maximum DC reverse current at rated DC		T _A = 25 °C		5.	0		
blocking voltage		T _A = 165 °C	IR I	150		μΑ	
Max. reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	75		ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	15		pF	

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYV26DGP	BYV26EGP	UNIT		
Typical thermal resistance	R _{0JA} ⁽¹⁾	70		°C/W		
Typical merma resistance	R _{θJL} ⁽²⁾	16				

Notes

(1) Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length, mounted on PCB with 0.5" x 0.5" (12 mm x 12 mm) copper pads

⁽²⁾ Thermal resistance from junction to lead at 0.375" (9.5 mm) lead length with both leads attached to heatsink

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
BYV26EGP-E3/54	0.428	54	4000	13" diameter paper tape and reel		
BYV26EGP-E3/73	0.428	73	2000	Ammo pack packaging		



BYV26DGP, BYV26EGP

Vishay General Semiconductor

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

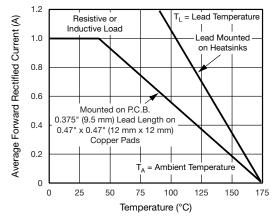


Fig. 1 - Maximum Forward Current Derating Curve

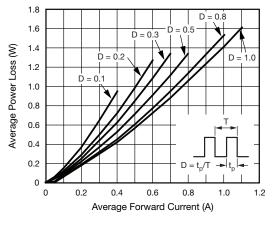


Fig. 2 - Forward Power Loss Characteristics

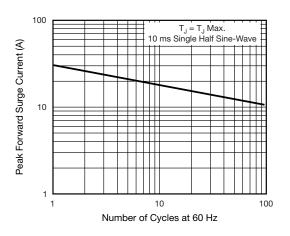


Fig. 3 - Maximum Non-Repetitive Peak Forward Surge Current

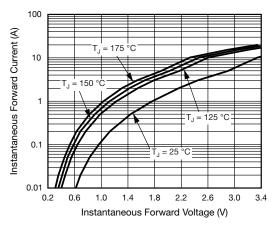


Fig. 4 - Typical Instantaneous Forward Voltage Characteristics

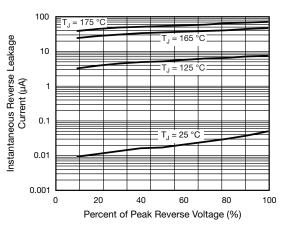


Fig. 5 - Typical Reverse Leakage Characteristics

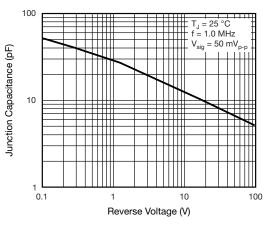


Fig. 6 - Typical Junction Capacitance

Revision: 06-Oct-2021

3

Document Number: 88554

For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u> Not for New Designs



BYV26DGP, BYV26EGP

Vishay General Semiconductor

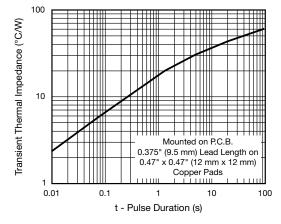
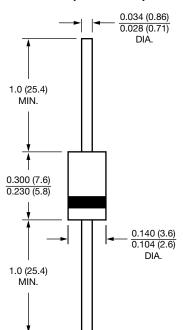


Fig. 7 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



DO-15 (DO-204AC)



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2025 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2025

1